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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	750
Number of Logic Elements/Cells	6000
Total RAM Bits	56320
Number of I/O	90
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-6e-5t144i

Modes of Operation

Each slice has up to four potential modes of operation: Logic, Ripple, RAM and ROM.

Logic Mode

In this mode, the LUTs in each slice are configured as 4-input combinatorial lookup tables. A LUT4 can have 16 possible input combinations. Any four input logic functions can be generated by programming this lookup table. Since there are two LUT4s per slice, a LUT5 can be constructed within one slice. Larger look-up tables such as LUT6, LUT7 and LUT8 can be constructed by concatenating other slices. Note LUT8 requires more than four slices.

Ripple Mode

Ripple mode supports the efficient implementation of small arithmetic functions. In ripple mode, the following functions can be implemented by each slice:

- Addition 2-bit
- Subtraction 2-bit
- Add/Subtract 2-bit using dynamic control
- Up counter 2-bit
- Down counter 2-bit
- Up/Down counter with Async clear
- Up/Down counter with preload (sync)
- Ripple mode multiplier building block
- Multiplier support
- Comparator functions of A and B inputs
 - A greater-than-or-equal-to B
 - A not-equal-to B
 - A less-than-or-equal-to B

Ripple Mode includes an optional configuration that performs arithmetic using fast carry chain methods. In this configuration (also referred to as CCU2 mode) two additional signals, Carry Generate and Carry Propagate, are generated on a per slice basis to allow fast arithmetic functions to be constructed by concatenating Slices.

RAM Mode

In this mode, a 16x4-bit distributed single port RAM (SPR) can be constructed using each LUT block in Slice 0 and Slice 2 as a 16x1-bit memory. Slice 1 is used to provide memory address and control signals. A 16x2-bit pseudo dual port RAM (PDPR) memory is created by using one Slice as the read-write port and the other companion slice as the read-only port.

The Lattice design tools support the creation of a variety of different size memories. Where appropriate, the software will construct these using distributed memory primitives that represent the capabilities of the PFU. Table 2-3 shows the number of slices required to implement different distributed RAM primitives. For more information about using RAM in LatticeECP2/M devices, please see the list of additional technical documentation at the end of this data sheet.

Table 2-3. Number of Slices Required to Implement Distributed RAM

	SPR 16X4	PDPR 16X4
Number of slices	3	3

Note: SPR = Single Port RAM, PDPR = Pseudo Dual Port RAM

Table 2-12. PIO Signals List

Name	Type	Description
CE0, CE1	Control from the core	Clock enables for input and output block flip-flops
CLK0, CLK1	Control from the core	System clocks for input and output blocks
ECLK1, ECLK2	Control from the core	Fast edge clocks
LSR	Control from the core	Local Set/Reset
GSRN	Control from routing	Global Set/Reset (active low)
INCK ²	Input to the core	Input to Primary Clock Network or PLL reference inputs
DQS	Input to PIO	DQS signal from logic (routing) to PIO
INDD	Input to the core	Unregistered data input to core
INFF	Input to the core	Registered input on positive edge of the clock (CLK0)
IPOS0, IPOS1	Input to the core	Double data rate registered inputs to the core
QPOS0 ¹ , QPOS1 ¹	Input to the core	Gearbox pipelined inputs to the core
QNEG0 ¹ , QNEG1 ¹	Input to the core	Gearbox pipelined inputs to the core
OPOS0, ONEG0, OPOS2, ONEG2	Output data from the core	Output signals from the core for SDR and DDR operation
OPOS1 ONEG1	Tristate control from the core	Signals to Tristate Register block for DDR operation
DEL[3:0]	Control from the core	Dynamic input delay control bits
TD	Tristate control from the core	Tristate signal from the core used in SDR operation
DDRCLKPOL	Control from clock polarity bus	Controls the polarity of the clock (CLK0) that feed the DDR input block
DQSXFER	Control from core	Controls signal to the Output block

1. Signals available on left/right/bottom only.

2. Selected I/O.

PIO

The PIO contains four blocks: an input register block, output register block, tristate register block and a control logic block. These blocks contain registers for operating in a variety of modes along with the necessary clock and selection logic.

Input Register Block

The input register blocks for PIOs in left, right and bottom edges contain delay elements and registers that can be used to condition high-speed interface signals, such as DDR memory interfaces and source synchronous interfaces, before they are passed to the device core. Figure 2-29 shows the diagram of the input register block for left, right and bottom edges. The input register block for the top edge contains one memory element to register the input signal as shown in Figure 2-30. The following description applies to the input register block for PIOs in the left, right and bottom edges of the device.

Input signals are fed from the sysI/O buffer to the input register block (as signal DI). If desired, the input signal can bypass the register and delay elements and be used directly as a combinatorial signal (INDD), a clock (INCK) and, in selected blocks, the input to the DQS delay block. If an input delay is desired, designers can select either a fixed delay or a dynamic delay DEL[3:0]. The delay, if selected, reduces input register hold time requirements when using a global clock.

The input block allows three modes of operation. In the single data rate (SDR) the data is registered, by one of the registers in the single data rate sync register block, with the system clock. In DDR Mode, two registers are used to sample the data on the positive and negative edges of the DQS signal, creating two data streams, D0 and D1. These two data streams are synchronized with the system clock before entering the core. Further discussion on this topic is in the DDR Memory section of this data sheet.

for checking soft errors (SED) in SRAM. SED can be run on a programmed device when the user logic is not active. If a soft error occurs, during user mode (normal operation) the device can be programmed to either reload from a known good boot image or generate an error signal.

For further information about Soft Error Detect (SED) support, please see the list of additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP2/M devices require a single external, 10K ohm $\pm 1\%$ value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

On-Chip Oscillator

Every LatticeECP2/M device has an internal CMOS oscillator which is used to derive a Master Clock for configuration. The oscillator and the Master Clock run continuously and are available to user logic after configuration is completed. The software default value of the Master Clock is 2.5MHz. Table 2-16 lists all the available Master Configuration Clock frequencies for normal non-encrypted mode and encrypted mode. When a different Master Clock is selected during the design process, the following sequence takes place:

1. Device powers up with a Master Clock frequency of 3.1MHz.
2. During configuration, users select a different master clock frequency.
3. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.
4. If the user does not select a master clock frequency, then the configuration bitstream defaults to the Master Clock frequency of 2.5MHz.

This internal CMOS oscillator is available to the user by routing it as an input clock to the clock tree. For further information about the use of this oscillator for configuration or user mode, please see the list of additional technical documentation at the end of this data sheet.

Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration

Non-Encrypted Mode CCLK (MHz)			Encrypted Mode CCLK (MHz)
2.5 ¹	13.0	45.0	2.5 ¹
4.3	15.0	55.0	5.4
5.4	20.0	60.0	10.0
6.9	26.0	—	—
8.1	30.0	—	—
9.2	34.0	—	—
10.0	41.0	130.0	—

1. Software default frequency.

Density Shifting

The LatticeECP2/M family is designed to ensure that different density devices in the same family and in the same package have the same pinout. Furthermore, the architecture ensures a high success rate when performing design migration from lower density devices to higher density devices. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likelihood of success in each case. Design migration between LatticeECP2 and LatticeECP2M families is not possible. For specific requirements relating to sysCONFIG pins of the ECP2M50, M70 and M100, see the Logic Signal Connections tables.

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{H_DELE}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
f _{MAX_IOE}	Clock Frequency of I/O and PFU Register	ECP2/M	—	420	—	357	—	311	MHz
General I/O Pin Parameters (using Primary Clock with PLL)¹									
t _{COPLL} ¹⁰	Clock to Output - PIO Output Register	LFE2-6	—	2.30	—	2.60	—	2.80	ns
		LFE2-12	—	2.30	—	2.60	—	2.80	ns
		LFE2-20	—	2.30	—	2.60	—	2.80	ns
		LFE2-35	—	2.30	—	2.60	—	2.80	ns
		LFE2-50	—	2.30	—	2.60	—	2.80	ns
		LFE2-70	—	2.30	—	2.60	—	2.80	ns
		LFE2M20	—	2.30	—	2.60	—	2.80	ns
		LFE2M35	—	2.30	—	2.60	—	2.80	ns
		LFE2M50	—	2.60	—	2.90	—	3.10	ns
		LFE2M70	—	2.60	—	2.90	—	3.10	ns
		LFE2M100	—	2.70	—	3.00	—	3.20	ns
t _{SUPLL}	Clock to Data Setup - PIO Input Register	LFE2-6	0.70	—	0.80	—	0.90	—	ns
		LFE2-12	0.70	—	0.80	—	0.90	—	ns
		LFE2-20	0.70	—	0.80	—	0.90	—	ns
		LFE2-35	0.70	—	0.80	—	0.90	—	ns
		LFE2-50	0.70	—	0.80	—	0.90	—	ns
		LFE2-70	0.70	—	0.80	—	0.90	—	ns
		LFE2M20	0.70	—	0.80	—	0.90	—	ns
		LFE2M35	0.70	—	0.80	—	0.90	—	ns
		LFE2M50	0.70	—	0.80	—	0.90	—	ns
		LFE2M70	0.70	—	0.80	—	0.90	—	ns
		LFE2M100	0.80	—	0.90	—	1.00	—	ns

LatticeECP2/M Family Timing Adders^{1, 2, 3} (Continued)
Over Recommended Operating Conditions

Buffer Type	Description	-7	-6	-5	Units
LVC MOS25_4mA	LVC MOS 2.5 4mA drive, slow slew rate	2.18	2.26	2.33	ns
LVC MOS25_8mA	LVC MOS 2.5 8mA drive, slow slew rate	2.19	2.35	2.51	ns
LVC MOS25_12mA	LVC MOS 2.5 12mA drive, slow slew rate	1.50	1.66	1.82	ns
LVC MOS25_16mA	LVC MOS 2.5 16mA drive, slow slew rate	1.60	1.59	1.58	ns
LVC MOS25_20mA	LVC MOS 2.5 20mA drive, slow slew rate	1.43	1.39	1.34	ns
LVC MOS18_4mA	LVC MOS 1.8 4mA drive, slow slew rate	2.22	2.27	2.32	ns
LVC MOS18_8mA	LVC MOS 1.8 8mA drive, slow slew rate	1.93	2.08	2.23	ns
LVC MOS18_12mA	LVC MOS 1.8 12mA drive, slow slew rate	1.43	1.51	1.58	ns
LVC MOS18_16mA	LVC MOS 1.8 16mA drive, slow slew rate	1.47	1.46	1.45	ns
LVC MOS15_4mA	LVC MOS 1.5 4mA drive, slow slew rate	2.32	2.38	2.43	ns
LVC MOS15_8mA	LVC MOS 1.5 8mA drive, slow slew rate	1.84	1.98	2.12	ns
LVC MOS12_2mA	LVC MOS 1.2 2mA drive, slow slew rate	2.52	2.63	2.74	ns
LVC MOS12_6mA	LVC MOS 1.2 6mA drive, slow slew rate	1.69	1.83	1.96	ns
PCI33	PCI33	0.04	0.04	0.04	ns

1. Timing Adders are characterized but not tested on every device.
 2. LVC MOS timing measured with the load specified in Switching Test Condition table.
 3. All other standards tested according to the appropriate specifications.
 4. These timing adders are measured with the recommended resistor values.
- Timing v.A 0.11

SERDES High Speed Data Receiver (LatticeECP2M Family Only)

Table 3-11. Serial Input Data Specifications

Symbol	Description	Min.	Typ.	Max.	Units
RX-CID _S	Stream of nontransitions ¹ (CID = Consecutive Identical Digits) @ 10 ⁻¹² BER		7 @ 3.125 Gbps 20 @ 1.25 Gbps		Bits
V _{RX-DIFF-S}	Differential input sensitivity	100	—	—	mV, p-p
V _{RX-IN}	Input levels	0	—	V _{CCR_X} + 0.8	V
V _{RX-CM-DC}	Input common mode range (DC coupled)	0.5	—	1.2	V
V _{RX-CM-AC}	Input common mode range (AC coupled) ³	0	—	1.5	V
T _{RX-RELOCK}	CDR re-lock time ²	—	—	3000	Bits
Z _{RX-TERM}	Input termination 50/75 Ohm/High Z	—	50		Ohms
RL _{RX-RL}	Return loss (without package)	—	9	—	dB

1. This is the number of bits allowed without a transition on the incoming data stream when using DC coupling.
2. This is the typical number of bit times to re-lock to a new phase of frequency within +/- 300 ppm, assuming 8b10b encoded data and the CDR is in lock state. When CDR is in un-lock state, or reset is applied, the total re-lock settling time will be approximately 4ms including analog settle time, calibration time, and acquisition time.
3. AC coupling is used to interface to LVPECL and LVDS.

Input Data Jitter Tolerance

A receiver's ability to tolerate incoming signal jitter is very dependent on jitter type. High speed serial interface standards have recognized the dependency on jitter type and have recently modified specifications to indicate tolerance levels for different jitter types as they relate to specific protocols (e.g. FC, etc.). Sinusoidal jitter is considered to be a worst case jitter type.

Table 3-12. Receiver Total Jitter Tolerance Specification¹

Description	Frequency	Condition	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	600 mV differential eye	—	—	0.54	UI, p-p
Random		600 mV differential eye	—	—	0.26	UI, p-p
Total		600 mV differential eye	—	—	0.80	UI, p-p
Deterministic	2.5 Gbps	600 mV differential eye	—	—	0.61	UI, p-p
Random		600 mV differential eye	—	—	0.22	UI, p-p
Total		600 mV differential eye	—	—	0.81	UI, p-p
Deterministic	1.25 Gbps	600 mV differential eye	—	—	0.53	UI, p-p
Random		600 mV differential eye	—	—	0.22	UI, p-p
Total		600 mV differential eye	—	—	0.80	UI, p-p
Deterministic	250 Mbps ²	600 mV differential eye	—	—	0.42	UI, p-p
Random		600 mV differential eye	—	—	0.10	UI, p-p
Total		600 mV differential eye	—	—	0.60	UI, p-p

1. Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, voltages are nominal, room temperature.
2. Jitter specification is limited by measurement equipment capability.

LatticeECP2M Pin Information Summary, LFE2M20 and LFE2M35

Pin Type		LFE2M20		LFE2M35		
		256 fpBGA	484 fpBGA	256 fpBGA	484 fpBGA	672 fpBGA
Single Ended User I/O		140	304	140	303	410
Differential Pair User I/O		70	152	70	151	199
Configuration	TAP Pins	5	5	5	5	5
	Muxed Pins	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7
Non Configuration	Muxed Pins	64	84	60	84	89
	Dedicated Pins	3	3	3	3	3
VCC		6	16	6	16	29
VCCAUX		4	8	4	8	17
VCCPLL		1	4	1	4	8
VCCIO	Bank0	1	4	1	4	5
	Bank1	1	3	1	3	4
	Bank2	2	4	2	4	5
	Bank3	2	4	2	4	5
	Bank4	2	4	2	4	4
	Bank5	2	4	2	4	5
	Bank6	2	4	2	4	5
	Bank7	2	4	2	4	5
	Bank8	1	2	1	2	2
GND, GND0 to GND7		22	57	22	57	80
NC		17	11	17	12	37
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	0/0	36/18	0/0	36/18	63/31
	Bank1	0/0	18/9	0/0	18/9	18/9
	Bank2	14/7	30/15	14/7	30/15	50/25
	Bank3	16/8	36/18	16/8	36/18	43/21
	Bank4	32/16	62/31	32/16	62/31	50/21
	Bank5	20/10	28/14	20/10	28/14	60/30
	Bank6	16/8	40/20	16/8	39/19	52/25
	Bank7	28/14	40/20	28/14	40/20	60/30
	Bank8	14/7	14/7	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0
	Bank2 (Right Edge)	3	7	3	7	12
	Bank3 (Right Edge)	4	9	4	9	11
	Bank4 (Bottom Edge)	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0
	Bank6 (Left Edge)	4	10	4	10	14
	Bank7 (Left Edge)	7	10	7	10	15
	Bank8 (Right Edge)	0	0	0	0	0

LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100

Pin Type		LFE2M50			LFE2M70		LFE2M100	
		484 fpBGA	672 fpBGA	900 fpBGA	900 fpBGA	1152 fpBGA	900 fpBGA	1152 fpBGA
Single Ended User I/O		270	372	410	416	436	416	520
Differential Pair User I/O		135	185	205	208	218	207	260
Configuration	TAP Pins	5	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7	7
Non Configuration	Muxed Pins	69	72	72	75	76	74	78
	Dedicated Pins	3	3	3	3	3	3	3
VCC		16	20	62	44	44	44	44
VCCAUX		8	26	18	16	12	16	12
VCCPLL		4	8	4	4	4	4	4
VCCIO	Bank0	4	5	6	6	7	6	7
	Bank1	3	4	6	6	7	6	7
	Bank2	4	5	9	9	9	9	9
	Bank3	4	5	9	9	9	9	9
	Bank4	4	4	6	6	7	6	7
	Bank5	4	5	6	6	7	6	7
	Bank6	4	5	9	9	9	9	9
	Bank7	4	5	9	9	9	9	9
	Bank8	2	2	2	2	2	2	2
GND, GND0 to GND7		57	80	122	122	134	122	134
NC		31	35	121	63	283	63	199
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	36/18	63/31	56/28	34/17	46/23	34/17	54/27
	Bank1	18/9	18/9	36/18	42/21	34/17	42/21	44/22
	Bank2	30/15	50/25	54/27	70/35	72/36	70/35	80/40
	Bank3	36/18	43/21	44/22	60/30	64/32	60/30	80/40
	Bank4	42/21	24/12	38/19	38/19	40/20	38/19	44/22
	Bank5	28/14	60/30	58/29	40/20	40/20	40/20	46/23
	Bank6	40/20	54/27	60/30	62/31	66/33	62/31	82/41
	Bank7	40/20	60/30	64/32	70/35	74/37	70/35	90/45
	Bank8	0/0	0/0	0/0	0/0	0/0	0/0	0/0
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0	0
	Bank2 (Right Edge)	7	12	13	17	18	17	20
	Bank3 (Right Edge)	9	11	11	15	16	15	20
	Bank4 (Bottom Edge)	0	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0	0
	Bank6 (Left Edge)	10	14	15	15	16	15	20
	Bank7 (Left Edge)	10	15	17	17	18	17	22
	Bank8 (Right Edge)	0	0	0	0	0	0	0

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
M8	PB8B	5	PCLKC5_0/BDQ6	C	PB26B	5	PCLKC5_0/BDQ24	C
GND	GNDIO5	-			GNDIO5	-		
P7	PB13A	4	PCLKT4_0/BDQ15	T	PB31A	4	PCLKT4_0/BDQ33	T
R8	PB13B	4	PCLKC4_0/BDQ15	C	PB31B	4	PCLKC4_0/BDQ33	C
VCCIO	VCCIO4	4			VCCIO4	4		
T5	PB14A	4	BDQ15	T	PB32A	4	BDQ33	T
T6	PB14B	4	BDQ15	C	PB32B	4	BDQ33	C
T8	PB15A	4	BDQS15	T	PB33A	4	BDQS33	T
GND	GNDIO4	-			GNDIO4	-		
R7	PB16A	4	BDQ15	T	PB34A	4	BDQ33	T
T9	PB15B	4	BDQ15	C	PB33B	4	BDQ33	C
T7	PB16B	4	BDQ15	C	PB34B	4	BDQ33	C
L8	PB17A	4	BDQ15	T	PB35A	4	BDQ33	T
VCCIO	VCCIO4	4			VCCIO4	4		
P8	PB18A	4	BDQ15	T	PB36A	4	BDQ33	T
L9	PB17B	4	BDQ15	C	PB35B	4	BDQ33	C
N8	PB18B	4	BDQ15	C	PB36B	4	BDQ33	C
R9	PB19A	4	BDQ15	T	PB37A	4	BDQ33	T
GND	GNDIO4	-			GNDIO4	-		
R10	PB19B	4	BDQ15	C	PB37B	4	BDQ33	C
-	-	-			VCCIO	4		
-	-	-			GNDIO4	4		
N9	PB20A	4	BDQ24	T	PB47A	4	BDQ51	T
T10	PB21A	4	BDQ24	T	PB48A	4	BDQ51	T
M9	PB20B	4	BDQ24	C	PB47B	4	BDQ51	C
R11	PB21B	4	BDQ24	C	PB48B	4	BDQ51	C
P10	PB22A	4	BDQ24	T	PB49A	4	BDQ51	T
N11	PB23A	4	BDQ24	T	PB50A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
N10	PB22B	4	BDQ24	C	PB49B	4	BDQ51	C
P11	PB23B	4	BDQ24	C	PB50B	4	BDQ51	C
T11	PB24A	4	BDQS24	T	PB51A	4	BDQS51	T
GND	GNDIO4	-			GNDIO4	-		
M11	PB25A	4	BDQ24	T	PB52A	4	BDQ51	T
T12	PB24B	4	BDQ24	C	PB51B	4	BDQ51	C
L11	PB25B	4	BDQ24	C	PB52B	4	BDQ51	C
T13	PB26A	4	BDQ24	T	PB53A	4	BDQ51	T
R13	PB27A	4	BDQ24	T	PB54A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
T14	PB26B	4	BDQ24	C	PB53B	4	BDQ51	C
P13	PB27B	4	BDQ24	C	PB54B	4	BDQ51	C
GND	GNDIO4	-			GNDIO4	-		
N12	PB28A	4	VREF2_4/BDQ24	T	PB55A	4	VREF2_4/BDQ51	T
M12	PB28B	4	VREF1_4/BDQ24	C	PB55B	4	VREF1_4/BDQ51	C
R15	CFG2	8			CFG2	8		

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D5	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C
E5	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T
G7	VCC	-			VCC	-		
G9	VCC	-			VCC	-		
H7	VCC	-			VCC	-		
J10	VCC	-			VCC	-		
K10	VCC	-			VCC	-		
K8	VCC	-			VCC	-		
G8	VCCAUX	-			VCCAUX	-		
H10	VCCAUX	-			VCCAUX	-		
J7	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
C5	VCCIO0	0			VCCIO0	0		
E7	VCCIO0	0			VCCIO0	0		
C12	VCCIO1	1			VCCIO1	1		
E10	VCCIO1	1			VCCIO1	1		
E14	VCCIO2	2			VCCIO2	2		
G12	VCCIO2	2			VCCIO2	2		
K12	VCCIO3	3			VCCIO3	3		
M14	VCCIO3	3			VCCIO3	3		
M10	VCCIO4	4			VCCIO4	4		
P12	VCCIO4	4			VCCIO4	4		
M7	VCCIO5	5			VCCIO5	5		
P5	VCCIO5	5			VCCIO5	5		
K5	VCCIO6	6			VCCIO6	6		
M3	VCCIO6	6			VCCIO6	6		
E3	VCCIO7	7			VCCIO7	7		
G5	VCCIO7	7			VCCIO7	7		
T15	VCCIO8	8			VCCIO8	8		
A1	GND	-			GND	-		
A16	GND	-			GND	-		
B12	GND	-			GND	-		
B5	GND	-			GND	-		
C8	GND	-			GND	-		
E15	GND	-			GND	-		
E2	GND	-			GND	-		
H14	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J3	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
M15	GND	-			GND	-		
M2	GND	-			GND	-		
P9	GND	-			GND	-		

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
B15	PT40B	1		C	PT49B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
A15	PT40A	1		T	PT49A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A14	PT39A	1		T	PT48A	1		T
B14	PT39B	1		C	PT48B	1		C
D14	PT37B	1		C	PT46B	1		C
E14	PT36B	1		C	PT45B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
C13	PT37A	1		T	PT46A	1		T
F14	PT36A	1		T	PT45A	1		T
A13	PT35B	1		C	PT44B	1		C
E13	PT34B	1		C	PT43B	1		C
VCCIO	VCCIO1	1			VCCIO1	1		
B13	PT35A	1		T	PT44A	1		T
D13	PT34A	1		T	PT43A	1		T
E12	PT33B	1		C	PT42B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
D12	PT33A	1		T	PT42A	1		T
A12	PT31B	1		C	PT40B	1		C
B12	PT30B	1	PCLKC1_0	C	PT39B	1	PCLKC1_0	C
VCCIO	VCCIO1	1			VCCIO1	1		
A11	PT31A	1		T	PT40A	1		T
C12	PT30A	1	PCLKT1_0	T	PT39A	1	PCLKT1_0	T
F12	XRES	1			XRES	1		
B10	PT28B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C
GNDIO	GNDIO0	-			GNDIO0	-		
B11	PT28A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T
C11	PT26B	0		C	PT35B	0		C
A10	PT27B	0		C	PT36B	0		C
C10	PT26A	0		T	PT35A	0		T
VCCIO	VCCIO0	0			VCCIO0	0		
A9	PT27A	0		T	PT36A	0		T
A8	PT24B	0		C	PT33B	0		C
E11	PT25B	0		C	PT34B	0		C
A7	PT24A	0		T	PT33A	0		T
F11	PT25A	0		T	PT34A	0		T
GNDIO	GNDIO0	-			GNDIO0	-		
B8	PT23B	0		C	PT32B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
B9	PT23A	0		T	PT32A	0		T
C8	PT20B	0		C	PT29B	0		C
B7	PT21B	0		C	PT30B	0		C
D8	PT20A	0		T	PT29A	0		T

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
Y21	PB64A	4	VREF2_4/BDQ60	T	PB73A	4	VREF2_4/BDQ69	T	
AB23	PB64B	4	VREF1_4/BDQ60	C	PB73B	4	VREF1_4/BDQ69	C	
GND	GNDIO4	-			GNDIO4	-			
AD24	CFG2	8			CFG2	8			
W20	CFG1	8			CFG1	8			
AC24	CFG0	8			CFG0	8			
V19	PROGRAMN	8			PROGRAMN	8			
AA22	CCLK	8			CCLK	8			
AB24	INITN	8			INITN	8			
AD25	DONE	8			DONE	8			
GND	GNDIO8	-			GNDIO8	-			
W21	PR44B	8	WRITEN	C	PR58B	8	WRITEN	C	
Y22	PR44A	8	CS1N	T	PR58A	8	CS1N	T	
AC25	PR43B	8	CSN	C	PR57B	8	CSN	C	
AB25	PR43A	8	D0/SPIFASTN	T	PR57A	8	D0/SPIFASTN	T	
VCCIO	VCCIO8	8			VCCIO8	8			
AD26	PR42B	8	D1	C	PR56B	8	D1	C	
AC26	PR42A	8	D2	T	PR56A	8	D2	T	
Y23	PR41B	8	D3	C	PR55B	8	D3	C	
GND	GNDIO8	-			GNDIO8	-			
W22	PR41A	8	D4	T	PR55A	8	D4	T	
AA25	PR40B	8	D5	C	PR54B	8	D5	C	
AB26	PR40A	8	D6	T	PR54A	8	D6	T	
W23	PR39B	8	D7/SPID0	C	PR53B	8	D7/SPID0	C	
VCCIO	VCCIO8	8			VCCIO8	8			
V22	PR39A	8	DI/CSSPI0N	T	PR53A	8	DI/CSSPI0N	T	
Y24	PR38B	8	DOU/CSON	C	PR52B	8	DOU/CSON	C	
Y25	PR38A	8	BUSY/SISPI	T	PR52A	8	BUSY/SISPI	T	
W24	PR37B	3	RDQ34	C	PR51B	3	RDQ48	C	
GND	GNDIO3	-			GNDIO3	-			
V23	PR37A	3	RDQ34	T	PR51A	3	RDQ48	T	
AA26	PR36B	3	RDQ34	C (LVDS)*	PR50B	3	RDQ48	C (LVDS)*	
Y26	PR36A	3	RDQ34	T (LVDS)*	PR50A	3	RDQ48	T (LVDS)*	
U21	PR35B	3	RDQ34	C	PR49B	3	RDQ48	C	
VCCIO	VCCIO3	3			VCCIO3	3			
U19	PR35A	3	RDQ34	T	PR49A	3	RDQ48	T	
W25	PR34B	3	RDQ34	C (LVDS)*	PR48B	3	RDQ48	C (LVDS)*	
W26	PR34A	3	RDQS34	T (LVDS)*	PR48A	3	RDQS48	T (LVDS)*	
GND	GNDIO3	-			GNDIO3	-			
V24	PR33B	3	RDQ34	C	PR47B	3	RDQ48	C	
V25	PR33A	3	RDQ34	T	PR47A	3	RDQ48	T	
V26	PR32B	3	RDQ34	C (LVDS)*	PR46B	3	RDQ48	C (LVDS)*	
U26	PR32A	3	RDQ34	T (LVDS)*	PR46A	3	RDQ48	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
U22	PR31B	3	RLM0_GPLL_C_FB_A/RDQ34	C	PR45B	3	RLM0_GPLL_C_FB_A/RDQ48	C	
U23	PR31A	3	RLM0_GPLL_T_FB_A/RDQ34	T	PR45A	3	RLM0_GPLL_T_FB_A/RDQ48	T	

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P3	PL54B	7	LDQ54	C (LVDS)*
R6	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7		
R8	PL55B	7	LDQ54	C
P2	PL56A	7	LDQ54	T (LVDS)*
P1	PL56B	7	LDQ54	C (LVDS)*
R5	PL57A	7	PCLKT7_0/LDQ54	T
GND	GNDIO7	-		
R7	PL57B	7	PCLKC7_0/LDQ54	C
R4	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
R3	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
T5	PL60A	6	VREF2_6/LDQ63	T
T7	PL60B	6	VREF1_6/LDQ63	C
T3	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6		
T4	PL61B	6	LDQ63	C (LVDS)*
T6	PL62A	6	LDQ63	T
T8	PL62B	6	LDQ63	C
T2	PL63A	6	LDQS63	T (LVDS)*
GND	GNDIO6	-		
T1	PL63B	6	LDQ63	C (LVDS)*
U7	PL64A	6	LDQ63	T
U5	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6		
U4	PL65A	6	LDQ63	T (LVDS)*
U3	PL65B	6	LDQ63	C (LVDS)*
U8	PL66A	6	LDQ63	T
U6	PL66B	6	LDQ63	C
GND	GNDIO6	-		
U2	PL67A	6	LDQ71	T (LVDS)*
U1	PL67B	6	LDQ71	C (LVDS)*
V7	PL68A	6	LDQ71	T
V5	PL68B	6	LDQ71	C
VCCIO	VCCIO6	6		
V2	PL69A	6	LDQ71	T (LVDS)*
V1	PL69B	6	LDQ71	C (LVDS)*
V8	PL70A	6	LDQ71	T
V6	PL70B	6	LDQ71	C
GND	GNDIO6	-		
W1	PL71A	6	LDQS71	T (LVDS)*
W2	PL71B	6	LDQ71	C (LVDS)*
W5	PL72A	6	LDQ71	T
VCCIO	VCCIO6	6		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
V23	PR70A	3	RDQ71	T
W27	PR69B	3	RDQ71	C (LVDS)*
W28	PR69A	3	RDQ71	T (LVDS)*
V26	PR68B	3	RDQ71	C
VCCIO	VCCIO3	3		
V24	PR68A	3	RDQ71	T
W29	PR67B	3	RDQ71	C (LVDS)*
W30	PR67A	3	RDQ71	T (LVDS)*
U25	PR66B	3	RDQ63	C
GND	GNDIO3	-		
U23	PR66A	3	RDQ63	T
V29	PR65B	3	RDQ63	C (LVDS)*
V30	PR65A	3	RDQ63	T (LVDS)*
U26	PR64B	3	RDQ63	C
VCCIO	VCCIO3	3		
U24	PR64A	3	RDQ63	T
U27	PR63B	3	RDQ63	C (LVDS)*
U28	PR63A	3	RDQS63	T (LVDS)*
GND	GNDIO3	-		
T23	PR62B	3	RDQ63	C
T25	PR62A	3	RDQ63	T
U29	PR61B	3	RDQ63	C (LVDS)*
U30	PR61A	3	RDQ63	T (LVDS)*
VCCIO	VCCIO3	3		
T24	PR60B	3	VREF2_3/RDQ63	C
T26	PR60A	3	VREF1_3/RDQ63	T
T27	PR59B	3	PCLKC3_0/RDQ63	C (LVDS)*
T28	PR59A	3	PCLKT3_0/RDQ63	T (LVDS)*
R24	PR57B	2	PCLKC2_0/RDQ54	C
R26	PR57A	2	PCLKT2_0/RDQ54	T
GND	GNDIO2	-		
T29	PR56B	2	RDQ54	C (LVDS)*
T30	PR56A	2	RDQ54	T (LVDS)*
R23	PR55B	2	RDQ54	C
R25	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2		
R27	PR54B	2	RDQ54	C (LVDS)*
R28	PR54A	2	RDQS54	T (LVDS)*
P26	PR53B	2	RDQ54	C
GND	GNDIO2	-		
P24	PR53A	2	RDQ54	T
R29	PR52B	2	RDQ54	C (LVDS)*
R30	PR52A	2	RDQ54	T (LVDS)*

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AF23	PB64A	4	BDQ60	T	LRC_SQ_HDINP1	13		T	
AD23	NC	-			LRC_SQ_VCCIB1	13			
AE23	PB66B	4	BDQ69	C	LRC_SQ_HDINN1	13		C	
AD24	VCC	-			LRC_SQ_VCCRX1	13			
AF20	PB55A	4	BDQ51	T	LRC_SQ_HDOUTP1	13		T	
AD20	NC	-			LRC_SQ_VCCOB1	13			
AE20	PB55B	4	BDQ51	C	LRC_SQ_HDOUTN1	13		C	
AD21	VCC	-			LRC_SQ_VCCTX1	13			
AE21	PB63B	4	BDQ60	C	LRC_SQ_HDOUTN0	13		C	
AF22	NC	-			LRC_SQ_VCCOB0	13			
AF21	PB62A	4	BDQ60	T	LRC_SQ_HDOUTP0	13		T	
AD22	VCC	-			LRC_SQ_VCCTX0	13			
AE24	PB67B	4	BDQ69	C	LRC_SQ_HDINN0	13		C	
AE25	NC	-			LRC_SQ_VCCIB0	13			
AF24	PB67A	4	BDQ69	T	LRC_SQ_HDINP0	13		T	
AD25	VCC	-			LRC_SQ_VCCRX0	13			
AA21	CFG2	8			CFG2	8			
AA22	CFG1	8			CFG1	8			
AB23	CFG0	8			CFG0	8			
AC26	PROGRAMN	8			PROGRAMN	8			
AB24	CCLK	8			CCLK	8			
AA23	INITN	8			INITN	8			
AB25	DONE	8			DONE	8			
GNDIO	GNDIO8	-			GNDIO8	-			
Y19	PR68B	8	WRITEN***	C	WRITEN***	8			
Y21	PR68A	8	CS1N***	T	CS1N***	8			
AB26	PR67B	8	CSN***	C	CSN***	8			
Y22	PR67A	8	D0/SPIFASTN***	T	D0/SPIFASTN***	8			
VCCIO	VCCIO8	8				8			
W19	PR66B	8	D1***	C	D1***	8			
Y20	PR66A	8	D2***	T	D2***	8			
W22	PR65B	8	D3***	C	D3***	8			
GNDIO	GNDIO8	-				-			
W18	PR65A	8	D4***	T	D4***	8			
Y23	PR64B	8	D5***	C	D5***	8			
AA24	PR64A	8	D6***	T	D6***	8			
W21	PR63B	8	D7/SPID0***	C	D7/SPID0***	8			
VCCIO	VCCIO8	8			VCCIO8	8			
V20	PR63A	8	DI/CSSPI0N***	T	DI/CSSPI0N***	8			
W23	PR62B	8	DOUT/CSON/CSSPI1N***	C	DOUT/CSON/ CSSPI1N***	8			
Y24	PR62A	8	BUSY/SISPI***	T	BUSY/SISPI***	8			
V19	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
V21	PR60B	3	RLM0_GDLLC_FB_A	C	PR65B	3	RLM0_GDLLC_FB_A	C	
GNDIO	GNDIO3	-			GNDIO3	-			
U19	PR60A	3	RLM0_GDLLT_FB_A/RDQ57	T	PR65A	3	RLM0_GDLLT_FB_A	T	
AA26	PR59B	3	RLM0_GDLLC_IN_A**/RDQ57	C (LVDS)*	PR64B	3	RLM0_GDLLC_IN_A	C*	
Y26	PR59A	3	RLM0_GDLLT_IN_A**/RDQ57	T (LVDS)*	PR64A	3	RLM0_GDLLT_IN_A	T*	
V23	PR58B	3	RLM0_GPLLC_IN_A**/RDQ57	C	PR63B	3	RLM0_GPLLC_IN_A	C	

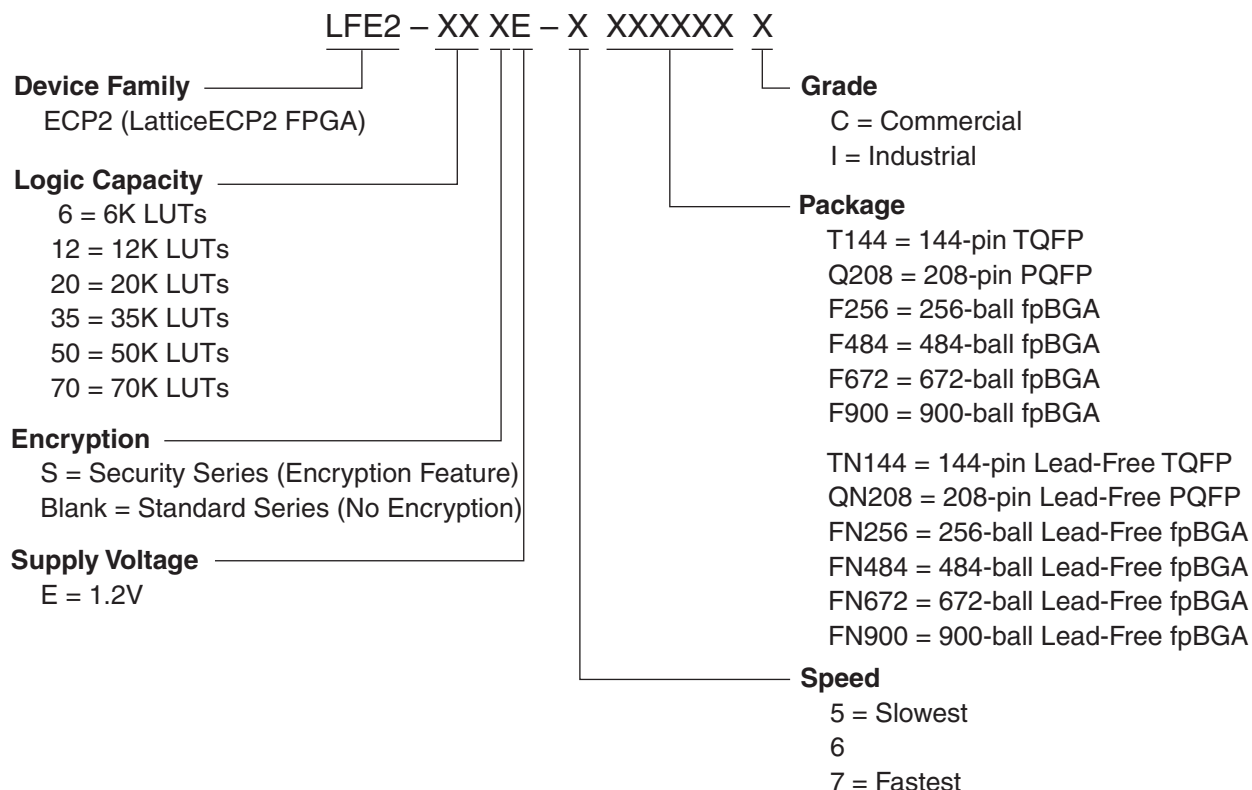
LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
T18	VCCAUX	-			VCCAUX	-			
T9	VCCAUX	-			VCCAUX	-			
V11	VCCAUX	-			VCCAUX	-			
V12	VCCAUX	-			VCCAUX	-			
V15	VCCAUX	-			VCCAUX	-			
V16	VCCAUX	-			VCCAUX	-			
A13	GND	-			GND	-			
A19	GND	-			GND	-			
A2	GND	-			GND	-			
A25	GND	-			GND	-			
AA2	GND	-			GND	-			
AA25	GND	-			GND	-			
AB18	GND	-			GND	-			
AB22	GND	-			GND	-			
AB5	GND	-			GND	-			
AB9	GND	-			GND	-			
AE1	GND	-			GND	-			
AE11	GND	-			GND	-			
AE16	GND	-			GND	-			
AE22	GND	-			GND	-			
AE26	GND	-			GND	-			
AE6	GND	-			GND	-			
AF13	GND	-			GND	-			
AF19	GND	-			GND	-			
AF2	GND	-			GND	-			
AF25	GND	-			GND	-			
B1	GND	-			GND	-			
B11	GND	-			GND	-			
B16	GND	-			GND	-			
B22	GND	-			GND	-			
B26	GND	-			GND	-			
B6	GND	-			GND	-			
E18	GND	-			GND	-			
E22	GND	-			GND	-			
E5	GND	-			GND	-			
E9	GND	-			GND	-			
F2	GND	-			GND	-			
F25	GND	-			GND	-			
G11	GND	-			GND	-			
G16	GND	-			GND	-			
J22	GND	-			GND	-			
J5	GND	-			GND	-			
K11	GND	-			GND	-			
K13	GND	-			GND	-			
K14	GND	-			GND	-			
K16	GND	-			GND	-			
L10	GND	-			GND	-			
L11	GND	-			GND	-			

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

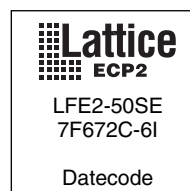
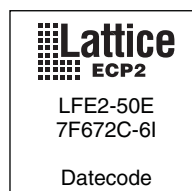
LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U8	PL43B	7	LUM3_SPLLC_FB_A/LDQ46	C	PL51B	7	LUM3_SPLLC_FB_A/LDQ54	C
VCCIO	VCCIO7	7			VCCIO7	7		
T6	PL44A	7	LDQ46	T (LVDS)*	PL52A	7	LDQ54	T (LVDS)*
R6	PL44B	7	LDQ46	C (LVDS)*	PL52B	7	LDQ54	C (LVDS)*
U9	PL45A	7	LDQ46	T	PL53A	7	LDQ54	T
T7	PL45B	7	LDQ46	C	PL53B	7	LDQ54	C
GNDIO	GNDIO7	-			GNDIO7	-		
U5	PL46A	7	LDQS46	T (LVDS)*	PL54A	7	LDQS54	T (LVDS)*
U6	PL46B	7	LDQ46	C (LVDS)*	PL54B	7	LDQ54	C (LVDS)*
U7	PL47A	7	LDQ46	T	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7			VCCIO7	7		
V9	PL47B	7	LDQ46	C	PL55B	7	LDQ54	C
V11	PL48A	7	LDQ46	T (LVDS)*	PL56A	7	LDQ54	T (LVDS)*
V10	PL48B	7	LDQ46	C (LVDS)*	PL56B	7	LDQ54	C (LVDS)*
U4	PL49A	7	PCLKT7_0/LDQ46	T	PL57A	7	PCLKT7_0/LDQ54	T
GNDIO	GNDIO7	-			GNDIO7	-		
U3	PL49B	7	PCLKC7_0/LDQ46	C	PL57B	7	PCLKC7_0/LDQ54	C
U2	PL51A	6	PCLKT6_0/LDQ55	T (LVDS)*	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
U1	PL51B	6	PCLKC6_0/LDQ55	C (LVDS)*	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
V5	PL52A	6	VREF2_6/LDQ55	T	PL60A	6	VREF2_6/LDQ63	T
V6	PL52B	6	VREF1_6/LDQ55	C	PL60B	6	VREF1_6/LDQ63	C
V7	PL53A	6	LDQ55	T (LVDS)*	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
V8	PL53B	6	LDQ55	C (LVDS)*	PL61B	6	LDQ63	C (LVDS)*
V4	PL54A	6	LDQ55	T	PL62A	6	LDQ63	T
V3	PL54B	6	LDQ55	C	PL62B	6	LDQ63	C
V2	PL55A	6	LDQS55	T (LVDS)*	PL63A	6	LDQS63	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
V1	PL55B	6	LDQ55	C (LVDS)*	PL63B	6	LDQ63	C (LVDS)*
W7	PL56A	6	LDQ55	T	PL64A	6	LDQ63	T
W5	PL56B	6	LDQ55	C	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6			VCCIO6	6		
W2	PL57A	6	LLM3_SPLLT_IN_A/LDQ55	T (LVDS)*	PL65A	6	LLM4_SPLLT_IN_A/LDQ63	T (LVDS)*
W1	PL57B	6	LLM3_SPLLC_IN_A/LDQ55	C (LVDS)*	PL65B	6	LLM4_SPLLC_IN_A/LDQ63	C (LVDS)*
Y6	PL58A	6	LLM3_SPLLT_FB_A/LDQ55	T	PL66A	6	LLM4_SPLLT_FB_A/LDQ63	T
W6	PL58B	6	LLM3_SPLLC_FB_A/LDQ55	C	PL66B	6	LLM4_SPLLC_FB_A/LDQ63	C
GNDIO	GNDIO6	-			GNDIO6	-		
Y1	PL60A	6	LDQ64	T (LVDS)*	PL68A	6	LDQ72	T (LVDS)*
Y2	PL60B	6	LDQ64	C (LVDS)*	PL68B	6	LDQ72	C (LVDS)*
Y7	PL61A	6	LDQ64	T	PL69A	6	LDQ72	T
Y5	PL61B	6	LDQ64	C	PL69B	6	LDQ72	C
VCCIO	VCCIO6	6			VCCIO6	6		
W10	PL62A	6	LDQ64	T (LVDS)*	PL70A	6	LDQ72	T (LVDS)*
Y8	PL62B	6	LDQ64	C (LVDS)*	PL70B	6	LDQ72	C (LVDS)*
Y4	PL63A	6	LDQ64	T	PL71A	6	LDQ72	T
Y3	PL63B	6	LDQ64	C	PL71B	6	LDQ72	C
GNDIO	GNDIO6	-			GNDIO6	-		
AA1	PL64A	6	LDQS64	T (LVDS)*	PL72A	6	LDQS72	T (LVDS)*
AA2	PL64B	6	LDQ64	C (LVDS)*	PL72B	6	LDQ72	C (LVDS)*

LatticeECP2 Part Number Description



Ordering Information

Note: LatticeECP2 devices are dual marked. For example, the commercial speed grade LFE2-50E-7F672C is also marked with industrial grade -6I (LFE2-50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:



LatticeECP2 Standard Series Devices, Lead-Free Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5TN144C	90	1.2V	-5	Lead-Free TQFP	144	COM	6
LFE2-6E-6TN144C	90	1.2V	-6	Lead-Free TQFP	144	COM	6
LFE2-6E-7TN144C	90	1.2V	-7	Lead-Free TQFP	144	COM	6
LFE2-6E-5FN256C	190	1.2V	-5	Lead-Free fpBGA	256	COM	6
LFE2-6E-6FN256C	190	1.2V	-6	Lead-Free fpBGA	256	COM	6
LFE2-6E-7FN256C	190	1.2V	-7	Lead-Free fpBGA	256	COM	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5TN144C	93	1.2V	-5	Lead-Free TQFP	144	COM	12
LFE2-12E-6TN144C	93	1.2V	-6	Lead-Free TQFP	144	COM	12
LFE2-12E-7TN144C	93	1.2V	-7	Lead-Free TQFP	144	COM	12
LFE2-12E-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	COM	12
LFE2-12E-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	COM	12
LFE2-12E-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	COM	12
LFE2-12E-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	COM	12
LFE2-12E-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	COM	12
LFE2-12E-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	COM	12
LFE2-12E-5FN484C	297	1.2V	-5	Lead-Free fpBGA	484	COM	12
LFE2-12E-6FN484C	297	1.2V	-6	Lead-Free fpBGA	484	COM	12
LFE2-12E-7FN484C	297	1.2V	-7	Lead-Free fpBGA	484	COM	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5QN208C	131	1.2V	-5	Lead-Free PQFP	208	COM	20
LFE2-20E-6QN208C	131	1.2V	-6	Lead-Free PQFP	208	COM	20
LFE2-20E-7QN208C	131	1.2V	-7	Lead-Free PQFP	208	COM	20
LFE2-20E-5FN256C	193	1.2V	-5	Lead-Free fpBGA	256	COM	20
LFE2-20E-6FN256C	193	1.2V	-6	Lead-Free fpBGA	256	COM	20
LFE2-20E-7FN256C	193	1.2V	-7	Lead-Free fpBGA	256	COM	20
LFE2-20E-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	COM	20
LFE2-20E-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	COM	20
LFE2-20E-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	COM	20
LFE2-20E-5FN672C	402	1.2V	-5	Lead-Free fpBGA	672	COM	20
LFE2-20E-6FN672C	402	1.2V	-6	Lead-Free fpBGA	672	COM	20
LFE2-20E-7FN672C	402	1.2V	-7	Lead-Free fpBGA	672	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5FN484C	331	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2-35E-6FN484C	331	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2-35E-7FN484C	331	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2-35E-5FN672C	450	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2-35E-6FN672C	450	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2-35E-7FN672C	450	1.2V	-7	Lead-Free fpBGA	672	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5FN484C	339	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2-50E-6FN484C	339	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2-50E-7FN484C	339	1.2V	-7	Lead-Free fpBGA	484	COM	50
LFE2-50E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2-50E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2-50E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5FN672C	500	1.2V	-5	Lead-Free fpBGA	672	COM	70
LFE2-70E-6FN672C	500	1.2V	-6	Lead-Free fpBGA	672	COM	70
LFE2-70E-7FN672C	500	1.2V	-7	Lead-Free fpBGA	672	COM	70
LFE2-70E-5FN900C	583	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2-70E-6FN900C	583	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2-70E-7FN900C	583	1.2V	-7	Lead-Free fpBGA	900	COM	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5TN144I	90	1.2V	-5	Lead-Free TQFP	144	IND	6
LFE2-6E-6TN144I	90	1.2V	-6	Lead-Free TQFP	144	IND	6
LFE2-6E-5FN256I	190	1.2V	-5	Lead-Free fpBGA	256	IND	6
LFE2-6E-6FN256I	190	1.2V	-6	Lead-Free fpBGA	256	IND	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5TN144I	93	1.2V	-5	Lead-Free TQFP	144	IND	12
LFE2-12E-6TN144I	93	1.2V	-6	Lead-Free TQFP	144	IND	12
LFE2-12E-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	IND	12
LFE2-12E-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	IND	12
LFE2-12E-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	IND	12
LFE2-12E-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	IND	12
LFE2-12E-5FN484I	297	1.2V	-5	Lead-Free fpBGA	484	IND	12
LFE2-12E-6FN484I	297	1.2V	-6	Lead-Free fpBGA	484	IND	12